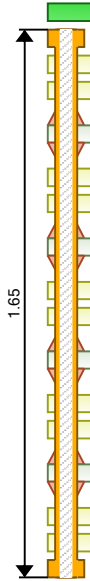


Layer	Stack up	Supplier	Supplier Description	Description	Type	Tg	εr	Base Thickness	Processed Thickness
1		Electra Polymers		Liquid Photolimageable Mask	SolderMask		4.000		
		Circuitfoil		Copper Foil	Copper			0.018	0.038
2		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.057
3		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.057
4		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.200	0.200
5		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
6		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
7		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.200	0.200
8		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
9		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
10		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.200	0.200
11		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
12		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
13		Shanghai Nanya	NY2150	NY2150 Core	FR4	150.000	4.200	0.200	0.200
14		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
15		Shanghai Nanya	NY2150	Prepreg1080	Dielectric	150.000	4.200	0.070	0.044
16		Circuitfoil		Copper Foil	Copper			0.018	0.038
17		Electra Polymers		Liquid Photolimageable Mask	SolderMask		4.000		



Copper Thickness = 0.356 | Dielectric Thickness = 1.290 | Solder Mask Thickness = 0.050 | Stack Up Thickness = 1.646 | Stack Up Thickness with Soldermask = 1.696 | Stack Up Cost = 68.00 |

Drill Image	1st Layer	2nd Layer	Column Position
	1	10	1

Notes

StackName: Mlb10_Standard1.6mm_TraX	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 1/1
Date: 2017/05/04	Associated Documents:					
Author: H.Ndala						
Department: Tech						
Site: Diep River						